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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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	ROSENBERG, P.C.		ZERVIGO	N, RUDY
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ATLANTA, (GA 30309-3915		1763	
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Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	10/511,389	GEISLER ET AL.			
Office Action Summary	Examiner	Art Unit			
	Rudy Zervigon	1763			
The MAILING DATE of this communication app Period for Reply A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.1: after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period v - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	Y IS SET TO EXPIRE 3 MONTH(ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be time will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONEI	S) OR THIRTY (30) DAYS, I. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
2a) ☐ This action is FINAL . 2b) ☐ This 3) ☐ Since this application is in condition for alloward	Responsive to communication(s) filed on <u>17 July 2006</u> . This action is FINAL . 2b) This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims					
 4) Claim(s) 1-10 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1-10 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement. 					
Application Papers					
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine	epted or b) objected to by the Eddrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	ite			

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DETAILED ACTION

Claim Rejections - 35 USC § 112

1. The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

2. Claim 9 is rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the enablement requirement. The claims contains subject matter which was not described in the specification in such a way as to enable one skilled in the art to which it pertains, or with which it is most nearly connected, to make and/or use the invention. Claim 9 requires cathode rotation, however, the specification does not sufficiently describe supporting structure therefore.

Claim Rejections - 35 USC § 103

- 3. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 4. Claims 1-3, 8, 10, and 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Szczyrbowski, Joachim et al. (US 20020157945 A1) in view of Mikata, Yuichi (US 20010012697 A1). Szczyrbowski teaches a coating installation (Figure 1; Section [0013]-[0015]) with a vacuum chamber (5; Figure 1; Section [0013]-[0015]) exhibiting an suction port (17; Figure 1) and a gas feed (9,10; Figure 1), in which a sputtering cathode (7; Figure 1) and a substrate holder (substrate :mounted"; not shown; [0013]) are arranged and for which the vacuum chamber (5; Figure 1; Section [0013]-[0015]) is divided into a cathode chamber (upper 5; Figure 1) and a substrate chamber (lower 5; Figure 1) by an screen (13'; Figure 1) arranged

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between the sputtering cathode (7; Figure 1) and the substrate holder (substrate :mounted"; not shown; [0013]) – claim 1

Szczyrbowski further teaches:

i. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1,

characterized in that the sputtering cathode (7; Figure 1) is a double magnetron cathode,

as claimed by claim 8

ii. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1,

characterized in that a metering device (18; Figure 1) for reactive gas is arranged in the

cathode chamber (upper 5; Figure 1) and that the regulated output (19; Figure 1) of the

sputtering cathode (7; Figure 1) exhibited in the coating installation (Figure 1; Section

[0013]-[0015]) is directly dependent on the concentration of the reactive gas in the

cathode chamber (upper 5; Figure 1), as claimed by claim 10

Szczyrbowski does not teach:

i. the cathode chamber (upper 5; Figure 1) as well as the substrate chamber (lower 5; Figure

1) each respectively exhibit a direct suction port (17; Figure 1) and their own gas feed

(9,10; Figure 1), and that the gas feed (9,10; Figure 1) into the cathode chamber (upper 5;

Figure 1) is connected to a process gas source and that the gas feed (9,10; Figure 1) for

the substrate chamber (lower 5; Figure 1) is connected to a reactive gas source – claim 1

ii. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1,

characterized in that the cathode chamber (upper 5; Figure 1) and the substrate chamber

(lower 5; Figure 1) are each respectively connected to their own vacuum pump stand (11,

17), as claimed by claim 2

iii. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that in the cathode chamber (upper 5; Figure 1) as well as in the substrate chamber (lower 5; Figure 1), the gas feed (9,10; Figure 1) and the suction port (17; Figure 1) are arranged on opposite sides, as claimed by claim 3

iv. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that the ratio of the focal aperture length of the screen (13'; Figure 1), measured in the transport direction of the substrate (8; Figure 1), to the width of the sputtering cathode (7; Figure 1), measured in the transport direction of the substrate (8; Figure 1), amounts to less than 0.75, preferably to between 0.5 and 0.3, as claimed by claim 11

Mikata teaches a deposition chamber (Figure 3) including a shutter (410; Figure 3) dividing the chamber in two. Each chamber is shown with its individual process gas supply (11,12) and exhaust ports (421, 419).

It would have been obvious to one of ordinary skill in the art at the time the invention was made for Szczyrbowski to add plural gas source ports and vaccum ports as taught by Mikata, and for Szczyrbowski to optimize the relative dimension of Szczyrbowski's apparatus.

Motivation for Szczyrbowski to add plural gas source ports and vaccum ports as taught by Mikata, and for Szczyrbowski to optimize the relative dimension of Szczyrbowski's apparatus is for promoting uniformity is procss gas distribution to reduce nonuniform depositions as taught by Mikata ([0005]). Further, it is well established that the duplication of parts is obvious (In re Harza, 274 F.2d 669, 124 USPQ 378 (CCPA 1960) MPEP 2144.04). Further, it is well established that changes in apparatus dimensions are within the level of ordinary skill in the

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art.(Gardner v. TEC Systems, Inc., 725 F.2d 1338, 220 USPQ 777 (Fed. Cir. 1984), cert. denied , 469 U.S. 830, 225 USPQ 232 (1984); In re Rose, 220 F.2d 459, 105 USPQ 237 (CCPA 1955); In re Rinehart, 531 F.2d 1048, 189 USPQ 143 (CCPA 1976); See MPEP 2144.04)

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- 5. Claims 4-7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata, Yuichi (US 20010012697 A1) in view of Szczyrbowski; Joachim et al. (US 5082546 A). Szczyrbowski and Mikata are discussed above. Szczyrbowski and Mikata do not teach:
 - i. Coating installation (Figure 1; Section [0013]-[0015]) according to claim 1, characterized in that an anode is arranged in the vacuum chamber (5; Figure 1; Section [0013]-[0015]) between the sputtering cathode (7; Figure 1) and the substrate (8; Figure 1), as claimed by claim 4
 - ii. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that the anode in the substrate chamber (lower 5; Figure 1) is arranged to be covered by the screen (13'; Figure 1) between the screen (13'; Figure 1) and the substrate holder (substrate :mounted"; not shown; [0013]), as claimed by claim 5
- iii. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that the anode is formed by two unheated tubes, as claimed by claim 6
- iv. Coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that the anode simultaneously forms the screen (13'; Figure 1), as claimed by claim 7

Szczyrbowski; Joachim et al. (US 5082546 A) teaches a sputtering apparatus (Sole Figuure; column 1; lines 14-40) including a tubular anode (6; Figure 1) arranged in the vacuum chamber

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between the cylindircal (tubular) sputtering cathode (3,3a-c; Sole Figure) and the substrate (1 Sole Figure). Lehan further teaches rotating cylindrical magnetron.

It would have been obvious to one of ordinary skill in the art at the time the invention was made for Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata to add Szczyrbowski; Joachim et al. (US 5082546 A) anode.

Motivation for Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata to add Szczyrbowski; Joachim et al. (US 5082546 A) anode is for arc-free and cleaning-free processing as taught by Szczyrbowski; Joachim et al. (US 5082546 A; column 1; lines 29-31).

6. Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata, Yuichi (US 20010012697 A1) in view of Lehan; John et al. (US 5814195 A). Szczyrbowski and Mikata are discussed above. Szczyrbowski and Mikata do not teach the coating installation (Figure 1; Section [0013]-[0015]) in accordance with claim 1, characterized in that the sputtering cathode (7; Figure 1) is a rotating cathode, as claimed by claim 9.

Lehan teaches a rotatable cylindrical magnetron (Figure 4) used in sputtering depostions.

It would have been obvious to one of ordinary skill in the art at the time the invention was made for Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata to replace Szczyrbowski's magnetron with Lehan's rotatable cylindrical magnetron (Figure 4).

Motivation for Szczyrbowski, Joachim et al. (US 20020157945 A1) and Mikata to replace Szczyrbowski's magnetron with Lehan's rotatable cylindrical magnetron (Figure 4) is for removing an anode as a contamination source during processing as taught by Lehan (column 1; lines 25-40).

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Response to Arguments

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7. Applicant's arguments filed July 17, 2006 have been fully considered but they are not

persuasive.

8. Applicant's argument with respect to the Examiner's rejection under 112, 1st paragraph is

not persuasive. That rotating cathodes are "well known" may be an accurate statement, however,

this premise is complicated by a wide array of shapes and structures for cathodes. In particular

one cathode may be more easily rotated in a particular reactor and another depending on the

shapes and structures of each. A skilled artisen may not know how to rotate Applicant's claim 9

cathode with Applicant's specified structures.

9. Applicant states:

The Examiner states that Mikata discloses an apparatus which has two chambers, each of which

is connected to a gas feed and an exhaust. The Examiner further contends that it would have been

obvious to one of ordinary skill in the art for Szczyrbowski to add plural gas source ports and

vacuum ports, as taught by Mikata. However, this combination of apparatuses would not be

operable.

Applicant then goes on to describe the operation of each of the Examiner's references. However,

Applicant states:

Mikata, therefore, teaches to separate the reactive gas and inert gas from each other by a cover.

This process would not work with Szczyrbowski because there must be a steady flow of particles

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modification of the cited references to include the elements of the present invention would

sputtered off the target onto the substrate for the apparatus in Szczyrbowski to function. Thus, a

prevent the respective Szczyrbowski and Mikata apparattzs from being used as designed, which

undermines an obviousness rejection.

In response, the Examiner notes that the Examiner's proposed combination does not include any reference to reproducing Mikata's "process" of "to separate the reactive gas and inert gas from each other by a cover". In fact, the Examiner's proposed combination states "It ... for Szczyrbowski to add plural gas source ports and vaccum ports as taught by Mikata, and for Szczyrbowski to optimize the relative dimension of Szczyrbowski's apparatus.". No reference is made for reproducing methods in either reference. The Examiner's proposed combination is strictly structural, as the pending apparatus claims are. That the Examiner's proposed combination would have motivation, and thus functionality once combined, is exhibited by Mikata ([0005]) whose gas introduction and exhausting arrangement supports promoting

10. In response to applicant's argument that the examiner's conclusion of obviousness is based upon improper hindsight reasoning, it must be recognized that any judgment on obviousness is in a sense necessarily a reconstruction based upon hindsight reasoning. But so long as it takes into account only knowledge which was within the level of ordinary skill at the time the claimed invention was made, and does not include knowledge gleaned only from the applicant's disclosure, such a reconstruction is proper. See In re McLaughlin, 443 F.2d 1392, 170 USPQ 209 (CCPA 1971).

uniformity is procss gas distribution to reduce nonuniform depositions.

Conclusion

11. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

12. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Examiner Rudy Zervigon whose telephone number is (571) 272-1442. The examiner can normally be reached on a Monday through Thursday schedule from 8am through 7pm. The official fax phone number for the 1763 art unit is (571) 273-8300. Any Inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Chemical and Materials Engineering art unit receptionist at (571) 272-1700. If the examiner can not be reached please contact the examiner's supervisor, Parviz Hassanzadeh, at (571) 272-1435.